

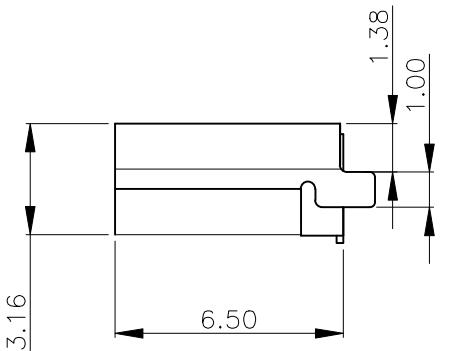
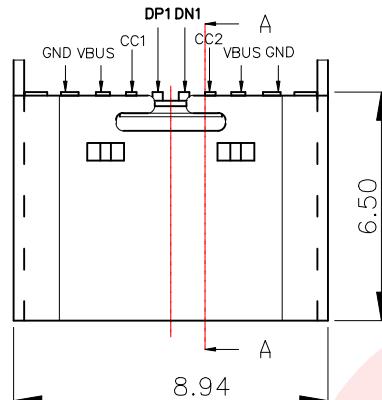


RoHS
Compliant
2011/65/EU

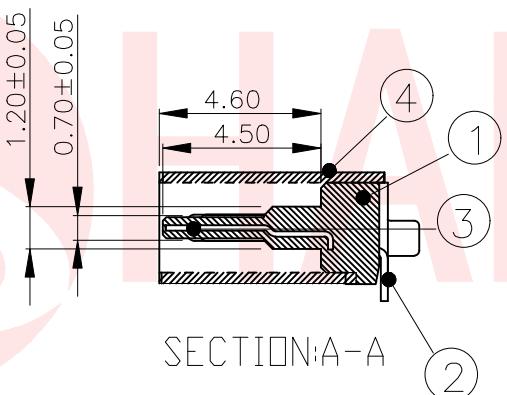
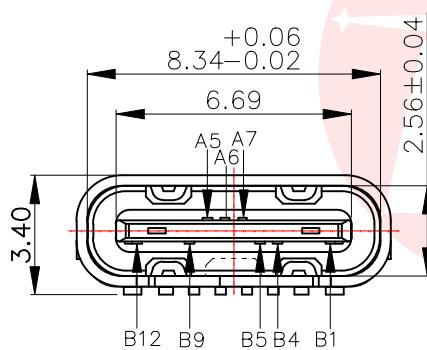


REV.	ECN NO OR DESCRIPTION	REVISED	DATE

A

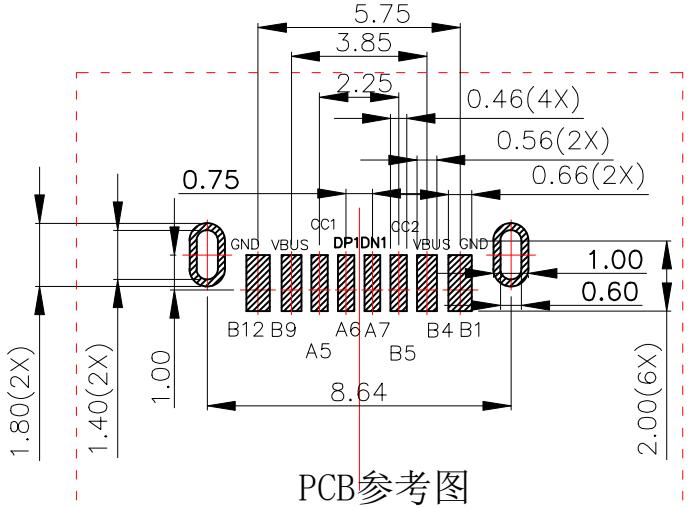
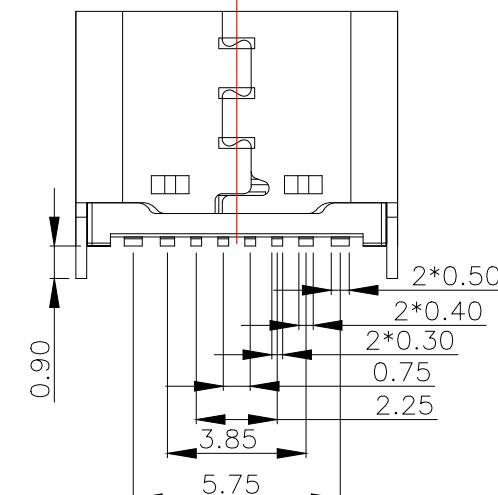


B



SECTION A-A

C



PCB 参考图

NOTE:

1. MATERIAL SPECIFICATION:
1.HOUSING:HIGH TEMPERATURE RESISTANT PLASTIC,UL94 V-0.
2.CONTACTS:COPPER ALLOY
3.MID PLATE: STAINLESS STEEL
4.FRONT SHELL: STAINLESS STEEL
- 2.PLATING SPECIFICATION:
2-1.CONTACTS:
Ni 50μ" MIN. UNDER PLATED OVER ALL.
Au PLATED ON THE FUNCTIONAL AREA OF CONTACT.
(GOLD PLATING THICKNESS FOLLOW THE P/N)
PLATING SPECIFICATIONS OF THE SOLDER AREA FOLLOW THE P/N
- 3.MECHANICAL PERFORMANCE,
3-1.INSERTION FORCE: 0.5~2.0kgf.
3-2.REMOVAL FORCE: 0.8kgf~2.0kgf.
3-3.DURABILITY: 10000 CYCLES.
- 4.ELECTRICAL PERFORMANCE,
4-1. CURRENT RATING:3.0A
VOLTAGE RATING:5.0V
4-2. LLCR:
VBUS & GND PINS AND OTHER PINS: 40mΩ/PIN MAX.
SHIELD: 50mΩ/MAX.
LLCR MAX. CHANGE OF ALL PINS: 10mΩ.
4-3. INSULATION RESISTANCE: 100MΩ MIN
4-4. DIELECTRIC WITHSTAND VOLTAGE,AC 100V FOR 1 MINUTE.
5. ENVIRONMENTAL PERFORMANCE:
OPERATING TEMPERATURE: -25~C~+85~C.
6. IR REFLOW:
THE PEAK TEMPERATURE ON THE BOARD SHALL
BE MAINTAINED FOR 10 SECONDS AT 260°C.

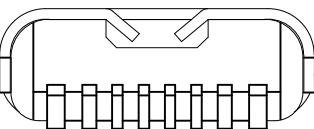
USB TYPE C PIN ASSIGNMENTS											
A1	A2	A3	A4	A5	A6	A7	A8	A9	A10	A11	A12
/	/	/	/	CC1	DP1	DN1	/	/	/	/	/

DECIMALS:	ANGLES:	TITLE	TYPE C 8P带钢片立贴6.5H无弹0.9脚长
X :±0.30	X :±2°	DWN	xiong
X.X :±0.20	X.X :±1°	CHKD	lee
X.XX :±0.02		APVD	wang
		SIZE: A4	SHEET:10F 1
		REV: A4	CUSTOMER COPY



东莞市汉博电子科技有限公司
DONGGUAN HANBO TECHNOLOGY CO., LTD

A



B

C

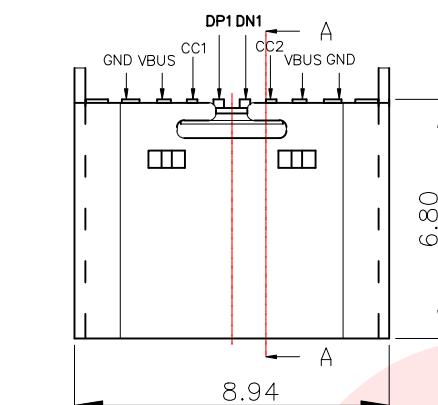
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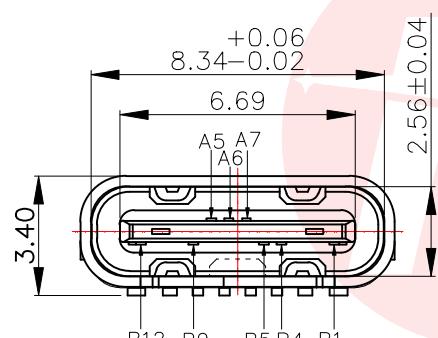
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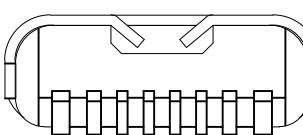
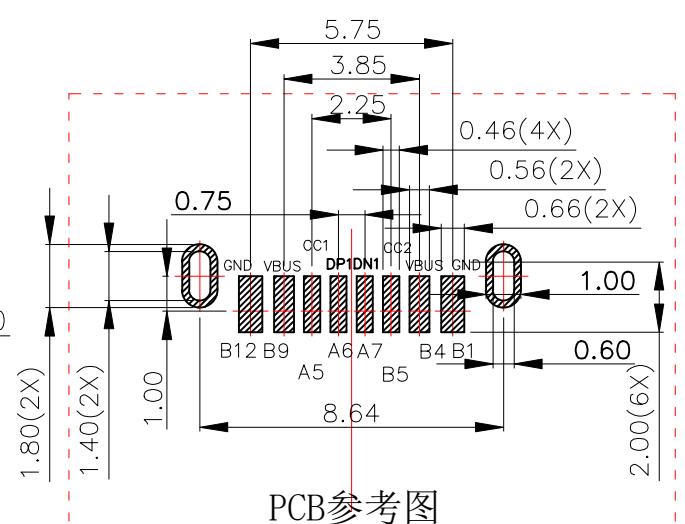
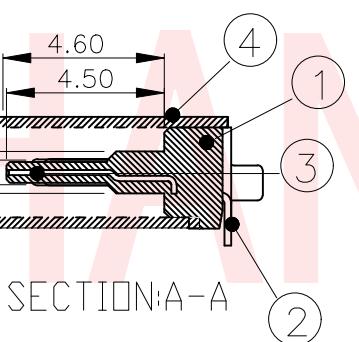
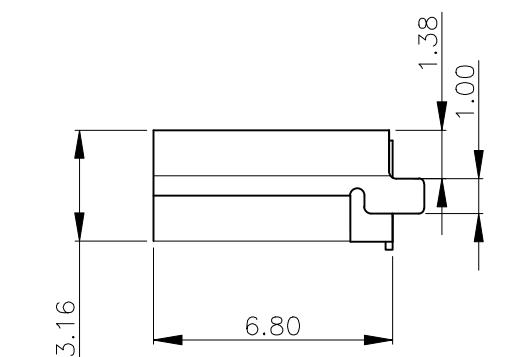
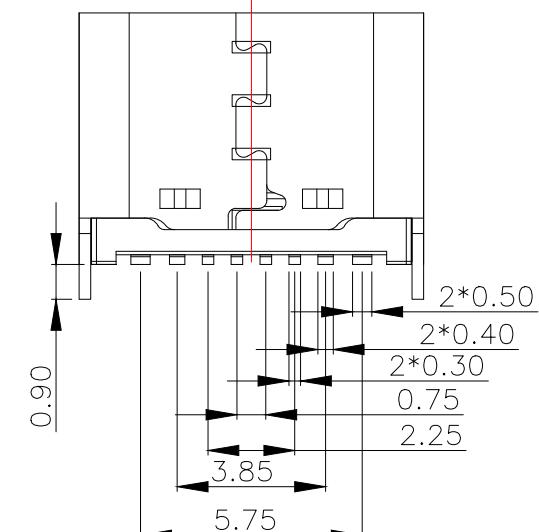
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USB TYPE C PIN ASSIGNMENTS

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/	/	/	/	CC1	DP1	DN1	/	/	/	/	/
GND	/	/	/	VBUS	/	/	CC2	VBUS	/	/	GND
B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1

UNLESS OTHERWISE
SPECIFIED TOLERANCES



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		REV: A4	CUSTOMER COPY